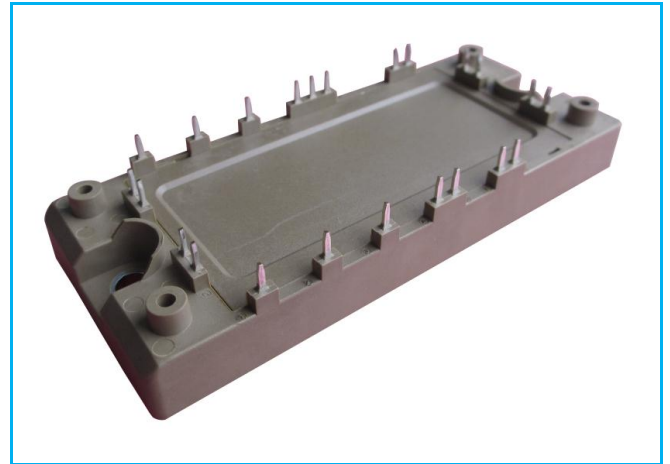


PRODUCT FEATURES

- High level of integration
- IGBT CHIP(Trench+Field Stop technology)
- Low saturation voltage and positive temperature coefficient
- Fast switching and short tail current
- Free wheeling diodes with fast and soft reverse recovery
- Industry standard package with insulated copper base plate and soldering pins for PCB mounting
- Temperature sense included

APPLICATIONS

- AC motor control
- Motion/servo control
- Inverter and power supplies



Rectifier+Brake+Inverter

IGBT-inverter

ABSOLUTE MAXIMUM RATINGS($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Values	Unit
V_{CES}	Collector Emitter Voltage	$T_J=25^\circ\text{C}$	1200	V
V_{GES}	Gate Emitter Voltage		± 20	
I_C	DC Collector Current	$T_C=25^\circ\text{C}, T_{Jmax}=175^\circ\text{C}$	76	A
		$T_C=100^\circ\text{C}, T_{Jmax}=175^\circ\text{C}$	50	
I_{CM}	Repetitive Peak Collector Current	$t_p=1\text{ms}$	100	
P_{tot}	Power Dissipation Per IGBT	$T_C=25^\circ\text{C}, T_{Jmax}=175^\circ\text{C}$	278	W

Diode-inverter

ABSOLUTE MAXIMUM RATINGS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Values	Unit
V_{RRM}	Repetitive Reverse Voltage	$T_J=25^\circ\text{C}$	1200	V
$I_{F(AV)}$	Average Forward Current		50	A
I_{FRM}	Repetitive Peak Forward Current	$t_p=1\text{ms}$	100	
I^2t		$T_J=125^\circ\text{C}, t=10\text{ms}, V_R=0\text{V}$	650	A^2s

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MMG50HD120XB6TC

IGBT-inverter

ELECTRICAL CHARACTERISTICS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit	
$V_{GE(th)}$	Gate Emitter Threshold Voltage	$V_{CE}=V_{GE}, I_C=2\text{mA}$	5.0	5.8	6.5	V	
$V_{CE(sat)}$	Collector Emitter Saturation Voltage	$I_C=50\text{A}, V_{GE}=15\text{V}, T_J=25^\circ\text{C}$		1.8	2.25		
		$I_C=50\text{A}, V_{GE}=15\text{V}, T_J=125^\circ\text{C}$		2.1			
		$I_C=50\text{A}, V_{GE}=15\text{V}, T_J=150^\circ\text{C}$		2.15			
I_{CES}	Collector Leakage Current	$V_{CE}=1200\text{V}, V_{GE}=0\text{V}, T_J=25^\circ\text{C}$			1	mA	
		$V_{CE}=1200\text{V}, V_{GE}=0\text{V}, T_J=150^\circ\text{C}$			10		
I_{GES}	Gate Leakage Current	$V_{CE}=0\text{V}, V_{GE}=\pm 20\text{V}, T_J=25^\circ\text{C}$	-400		400	nA	
R_{Gint}	Integrated Gate Resistor			3		Ω	
Q_G	Gate Charge	$V_{CE}=600\text{V}, I_C=50\text{A}, V_{GE}=15\text{V}$		0.27		μC	
C_{ies}	Input Capacitance	$V_{CE}=25\text{V}, V_{GE}=0\text{V}, f=1\text{MHz}$		3.5		nF	
C_{res}	Reverse Transfer Capacitance				160		pF
$t_{d(on)}$	Turn on Delay Time	$V_{CC}=600\text{V}, I_C=50\text{A}$ $R_G=7.5\Omega,$ $V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		30	ns	
			$T_J=125^\circ\text{C}$		35	ns	
			$T_J=150^\circ\text{C}$		35	ns	
t_r	Rise Time		$T_J=25^\circ\text{C}$		25	ns	
			$T_J=125^\circ\text{C}$		30	ns	
			$T_J=150^\circ\text{C}$		30	ns	
$t_{d(off)}$	Turn off Delay Time	$T_J=25^\circ\text{C}$		230	ns		
		$T_J=125^\circ\text{C}$		290	ns		
		$T_J=150^\circ\text{C}$		310	ns		
t_f	Fall Time	$T_J=25^\circ\text{C}$		130	ns		
		$T_J=125^\circ\text{C}$		190	ns		
		$T_J=150^\circ\text{C}$		210	ns		
E_{on}	Turn on Energy	$V_{CC}=600\text{V}, I_C=50\text{A}$ $R_G=7.5\Omega,$ $V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=125^\circ\text{C}$		6	mJ	
			$T_J=150^\circ\text{C}$		6.9	mJ	
E_{off}	Turn off Energy		$T_J=125^\circ\text{C}$		4	mJ	
			$T_J=150^\circ\text{C}$		4.5	mJ	
I_{SC}	Short Circuit Current		$t_{psc} \leq 10\mu\text{s}, V_{GE}=15\text{V}$ $T_J=150^\circ\text{C}, V_{CC}=800\text{V}$		200		A
R_{thJC}	Junction to Case Thermal Resistance (Per IGBT)				0.54	K/W	

Diode-inverter

ELECTRICAL CHARACTERISTICS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
V_F	Forward Voltage	$I_F=50\text{A}, V_{GE}=0\text{V}, T_J=25^\circ\text{C}$		1.9	2.3	V
		$I_F=50\text{A}, V_{GE}=0\text{V}, T_J=125^\circ\text{C}$		1.6		
		$I_F=50\text{A}, V_{GE}=0\text{V}, T_J=150^\circ\text{C}$		1.55		
t_{rr}	Reverse Recovery Time	$I_F=50\text{A}, V_R=600\text{V}$ $di_F/dt=-2300\text{A}/\mu\text{s}$ $T_J=150^\circ\text{C}$		130		ns
I_{RRM}	Max. Reverse Recovery Current			122		A
Q_{RR}	Reverse Recovery Charge			17.2		μC
E_{rec}	Reverse Recovery Energy			6.5		mJ
R_{thJCD}	Junction to Case Thermal Resistance (Per Diode)				0.81	K/W

MMG50HD120XB6TC

Diode-RECTIFIER

ABSOLUTE MAXIMUM RATINGS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Values	Unit
V_{RRM}	Repetitive Reverse Voltage	$T_J=25^\circ\text{C}$	2000	V
$I_{F(AV)}$	Average Forward Current Per Diode	$T_C=80^\circ\text{C}$	30	A
I_{FRMS}	R.M.S. Forward Current Per Diode		75	
I_{RMS}	R.M.S. Current at rectifier output		80	
I_{FSM}	Non Repetitive Surge Forward Current	$T_J=45^\circ\text{C}$, $t=10\text{ms}$, 50Hz	500	
		$T_J=45^\circ\text{C}$, $t=8.3\text{ms}$, 60Hz	560	
I^2t		$T_J=45^\circ\text{C}$, $t=10\text{ms}$, 50Hz	1250	A^2s
		$T_J=45^\circ\text{C}$, $t=8.3\text{ms}$, 60Hz	1250	

Diode-RECTIFIER

ELECTRICAL CHARACTERISTICS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
V_F	Forward Voltage	$I_F=50\text{A}$, $T_J=25^\circ\text{C}$		1.1	1.25	V
		$I_F=50\text{A}$, $T_J=150^\circ\text{C}$		1.00		V
I_R	Reverse Leakage Current	$V_R=1600\text{V}$, $T_J=25^\circ\text{C}$			50	μA
		$V_R=1600\text{V}$, $T_J=150^\circ\text{C}$			1	mA
R_{thJCD}	Junction to Case Thermal Resistance (Per Diode)				0.8	K /W

IGBT-Brake chopper

ABSOLUTE MAXIMUM RATINGS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Values	Unit
V_{CES}	Collector Emitter Voltage	$T_J=25^\circ\text{C}$	1200	V
V_{GES}	Gate Emitter Voltage		± 20	
I_C	DC Collector Current	$T_C=25^\circ\text{C}$, $T_{Jmax}=175^\circ\text{C}$	54	A
		$T_C=100^\circ\text{C}$, $T_{Jmax}=175^\circ\text{C}$	35	
I_{CM}	Repetitive Peak Collector Current	$t_p=1\text{ms}$	70	
P_{tot}	Power Dissipation Per IGBT	$T_C=25^\circ\text{C}$, $T_{Jmax}=175^\circ\text{C}$	208	W

Diode-Brake chopper

ABSOLUTE MAXIMUM RATINGS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Values	Unit
V_{RRM}	Repetitive Reverse Voltage	$T_J=25^\circ\text{C}$	1200	V
$I_{F(AV)}$	Average Forward Current		25	A
I_{FRM}	Repetitive Peak Forward Current	$t_p=1\text{ms}$	50	
I^2t		$T_J=125^\circ\text{C}$, $t=10\text{ms}$, $V_R=0\text{V}$	130	A^2s

MMG50HD120XB6TC

IGBT-Brake chopper

ELECTRICAL CHARACTERISTICS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit	
$V_{GE(th)}$	Gate Emitter Threshold Voltage	$V_{CE}=V_{GE}, I_C=1.2\text{mA}$	5.0	5.7	6.5	V	
$V_{CE(sat)}$	Collector Emitter Saturation Voltage	$I_C=35\text{A}, V_{GE}=15\text{V}, T_J=25^\circ\text{C}$		1.8	2.25		
		$I_C=35\text{A}, V_{GE}=15\text{V}, T_J=125^\circ\text{C}$		2			
		$I_C=35\text{A}, V_{GE}=15\text{V}, T_J=150^\circ\text{C}$		2.05			
I_{CES}	Collector Leakage Current	$V_{CE}=1200\text{V}, V_{GE}=0\text{V}, T_J=25^\circ\text{C}$			1	mA	
		$V_{CE}=1200\text{V}, V_{GE}=0\text{V}, T_J=150^\circ\text{C}$			10		
I_{GES}	Gate Leakage Current	$V_{CE}=0\text{V}, V_{GE}=\pm 20\text{V}, T_J=25^\circ\text{C}$	-400		400	nA	
R_{Gint}	Integrated Gate Resistor			0		Ω	
Q_G	Gate Charge	$V_{CE}=600\text{V}, I_C=35\text{A}, V_{GE}=15\text{V}$		0.21		μC	
C_{ies}	Input Capacitance	$V_{CE}=25\text{V}, V_{GE}=0\text{V}, f=1\text{MHz}$		2.8		nF	
C_{res}	Reverse Transfer Capacitance				110		pF
$t_{d(on)}$	Turn on Delay Time	$V_{CC}=600\text{V}, I_C=35\text{A}$ $R_G=20\Omega,$ $V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		25	ns	
			$T_J=125^\circ\text{C}$		30	ns	
			$T_J=150^\circ\text{C}$		30	ns	
t_r	Rise Time		$T_J=25^\circ\text{C}$		30	ns	
			$T_J=125^\circ\text{C}$		35	ns	
			$T_J=150^\circ\text{C}$		35	ns	
$t_{d(off)}$	Turn off Delay Time	$T_J=25^\circ\text{C}$		220	ns		
		$T_J=125^\circ\text{C}$		270	ns		
		$T_J=150^\circ\text{C}$		290	ns		
t_f	Fall Time	$T_J=25^\circ\text{C}$		170	ns		
		$T_J=125^\circ\text{C}$		240	ns		
		$T_J=150^\circ\text{C}$		260	ns		
E_{on}	Turn on Energy	$V_{CC}=600\text{V}, I_C=35\text{A}$ $R_G=20\Omega,$ $V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=125^\circ\text{C}$		4	mJ	
			$T_J=150^\circ\text{C}$		4.4	mJ	
E_{off}	Turn off Energy		$T_J=125^\circ\text{C}$		3.3	mJ	
			$T_J=150^\circ\text{C}$		3.7	mJ	
I_{SC}	Short Circuit Current		$t_{psc}\leq 10\mu\text{s}, V_{GE}=15\text{V}$ $T_J=150^\circ\text{C}, V_{CC}=800\text{V}$		145		A
R_{thJC}	Junction to Case Thermal Resistance (Per IGBT)				0.72	K/W	

Diode-Brake chopper

ELECTRICAL CHARACTERISTICS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
V_F	Forward Voltage	$I_F=25\text{A}, V_{GE}=0\text{V}, T_J=25^\circ\text{C}$		1.8	2.3	V
		$I_F=25\text{A}, V_{GE}=0\text{V}, T_J=125^\circ\text{C}$		1.55		
		$I_F=25\text{A}, V_{GE}=0\text{V}, T_J=150^\circ\text{C}$		1.5		
t_{rr}	Reverse Recovery Time	$I_F=25\text{A}, V_R=600\text{V}$ $di_F/dt=-1000\text{A}/\mu\text{s}$ $T_J=150^\circ\text{C}$		267		ns
I_{RRM}	Max. Reverse Recovery Current			44		A
Q_{RR}	Reverse Recovery Charge			6.2		μC
E_{rec}	Reverse Recovery Energy			2.4		mJ
R_{thJCD}	Junction to Case Thermal Resistance (Per Diode)				1.4	K/W

MMG50HD120XB6TC

NTC CHARACTERISTICS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions	Min.	Typ.	Max.	Unit
R_{25}	Resistance $T_C=25^\circ\text{C}$		5		k Ω
$B_{25/50}$	$R_2 = R_{25} \exp [B_{25/50}(1/T_2 - 1/(298.15 \text{ K}))]$		3375		K

MODULE CHARACTERISTICS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions	Values	Unit	
T_{Jmax}	Max. Junction Temperature	Inverter, Brake-Chopper	175	
		Rectifier	150	
T_{Jop}	Operating Temperature	-40~150	$^\circ\text{C}$	
T_{stg}	Storage Temperature	-40~125		
V_{isol}	Isolation Breakdown Voltage	AC, 50Hz(R.M.S), t=1minute		3000
CTI	Comparative Tracking Index		>200	
Md	Mounting Torque	Recommended (M5)	2.5~5	Nm
Weight			180	g

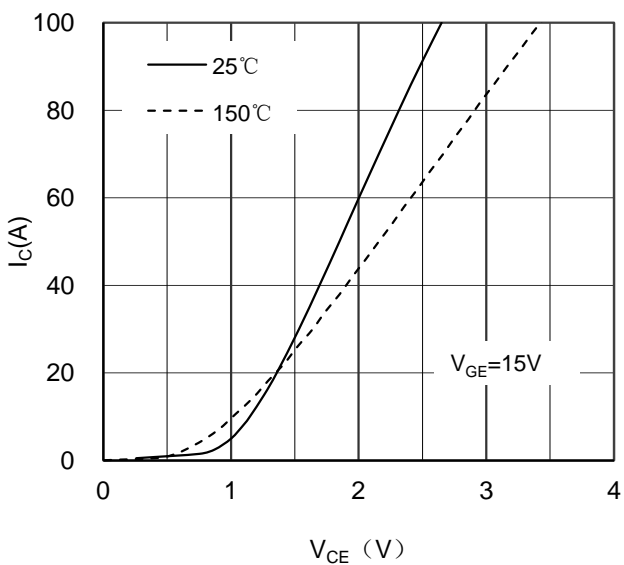


Figure 1. Typical Output Characteristics IGBT-inverter

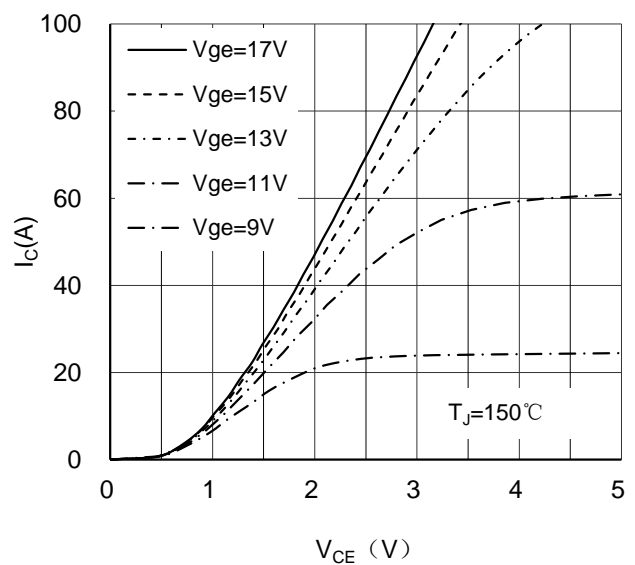


Figure 2. Typical Output Characteristics IGBT-inverter

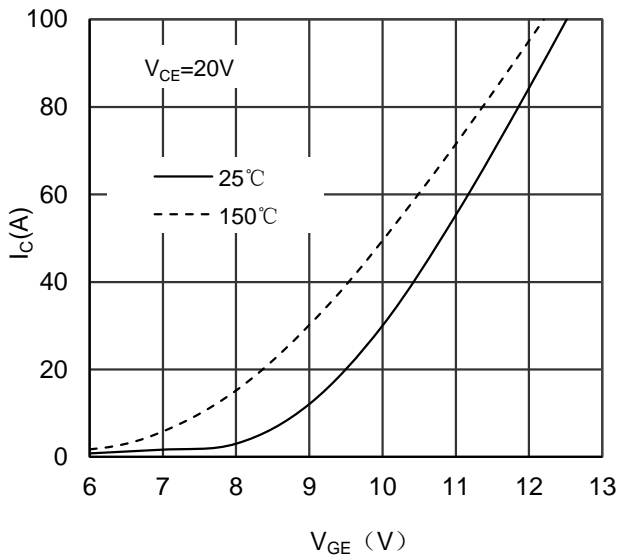


Figure 3. Typical Transfer characteristics IGBT-inverter

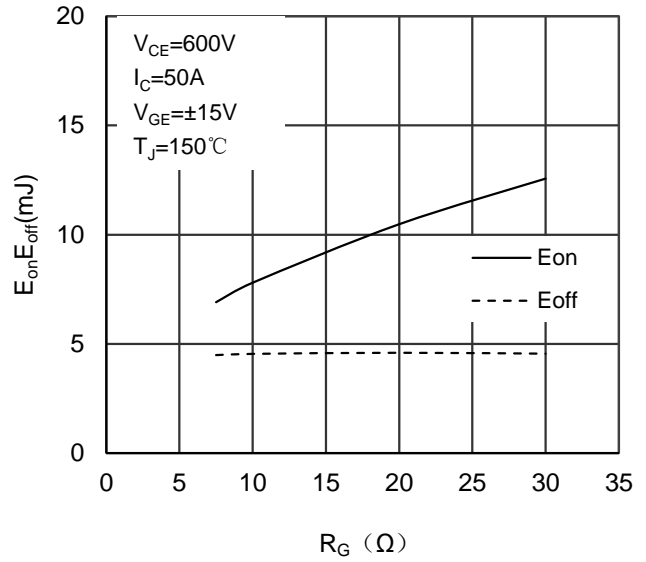


Figure 4. Switching Energy vs Gate Resistor IGBT-inverter

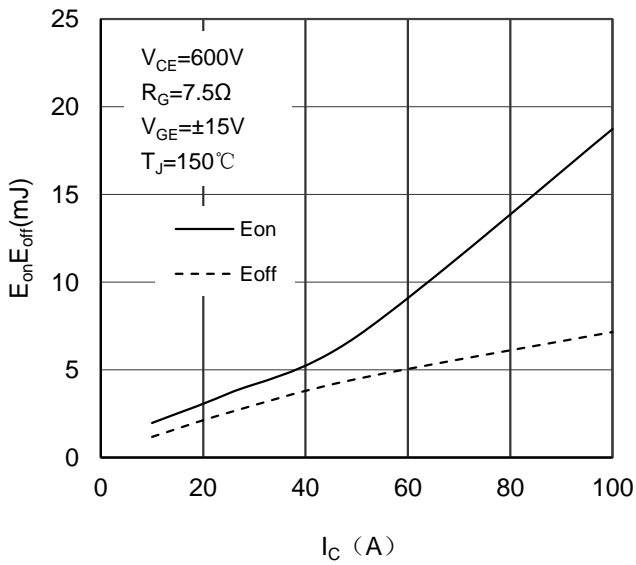


Figure 5. Switching Energy vs Collector Current IGBT-inverter

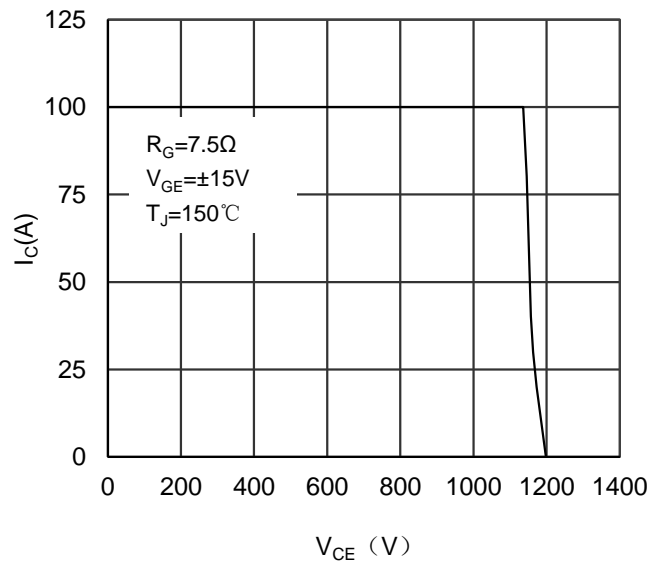


Figure 6. Reverse Biased Safe Operating Area IGBT-inverter

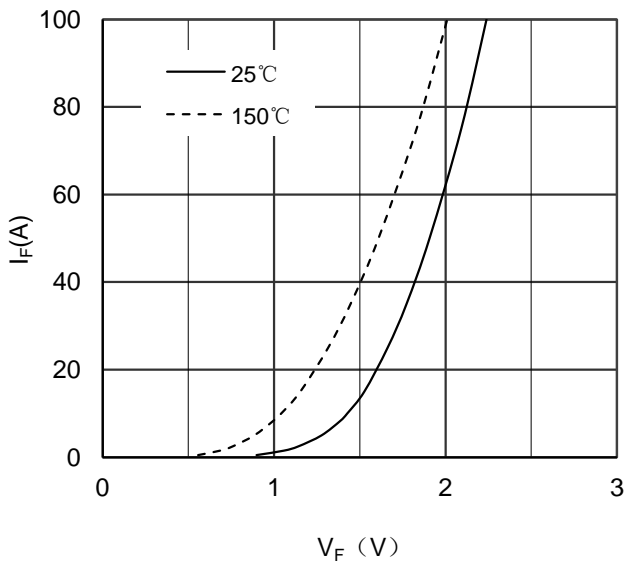


Figure 7. Diode Forward Characteristics Diode -inverter

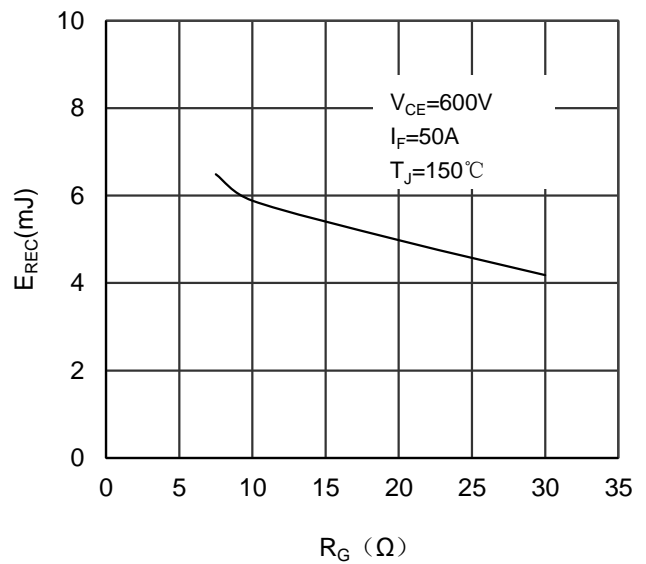


Figure 8. Switching Energy vs Gate Resistor Diode -inverter

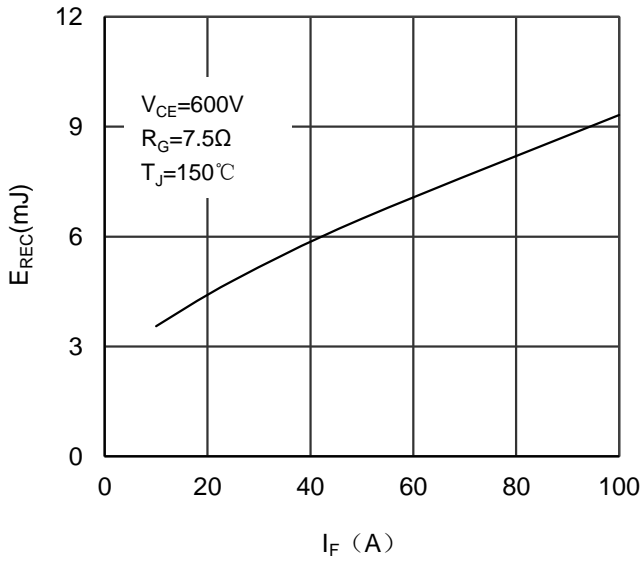


Figure 9. Switching Energy vs Forward Current Diode-inverter

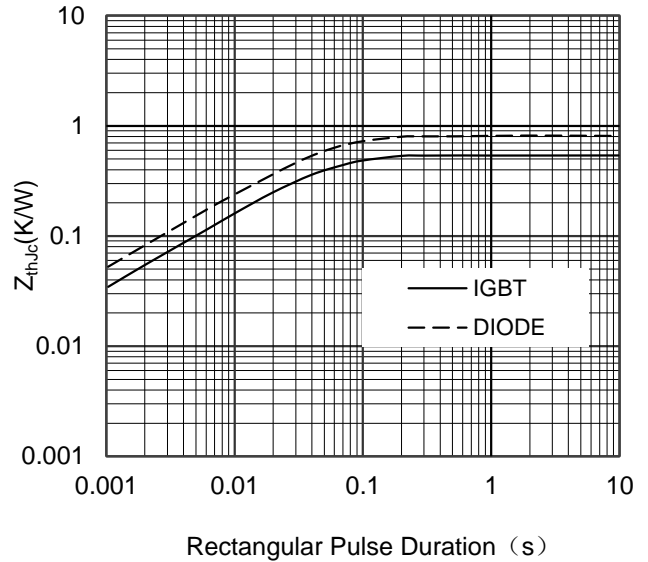


Figure 10. Transient Thermal Impedance of Diode and IGBT-inverter

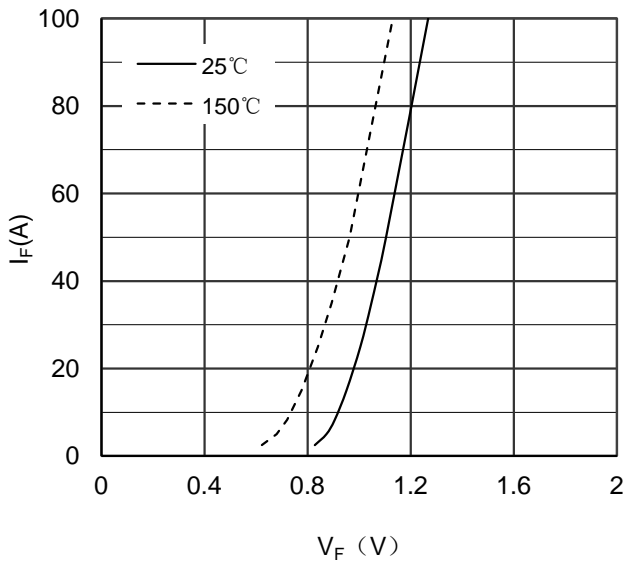


Figure 11. Diode Forward Characteristics Diode-rectifier

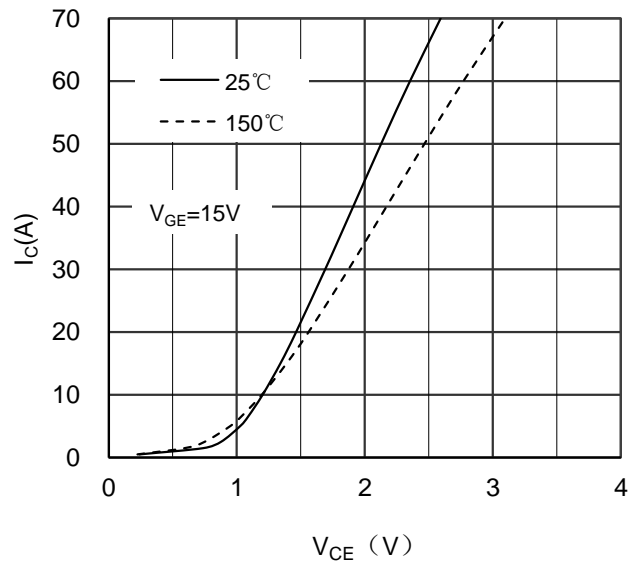


Figure 12. Typical Output Characteristics IGBT-brake chopper

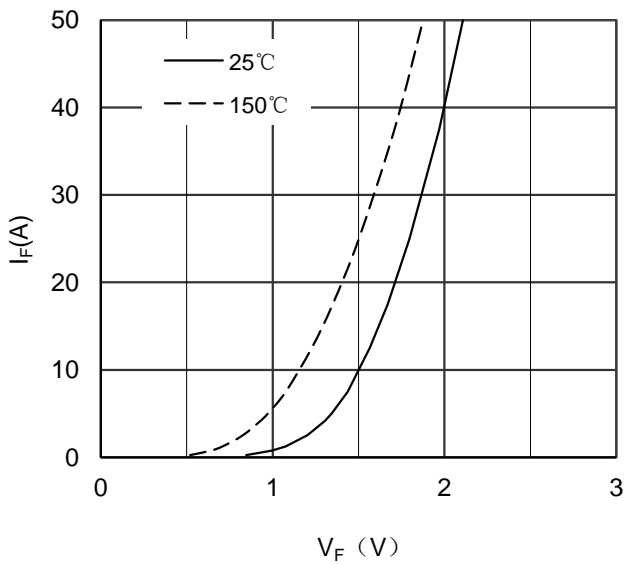


Figure 13. Diode Forward Characteristics Diode-brake chopper

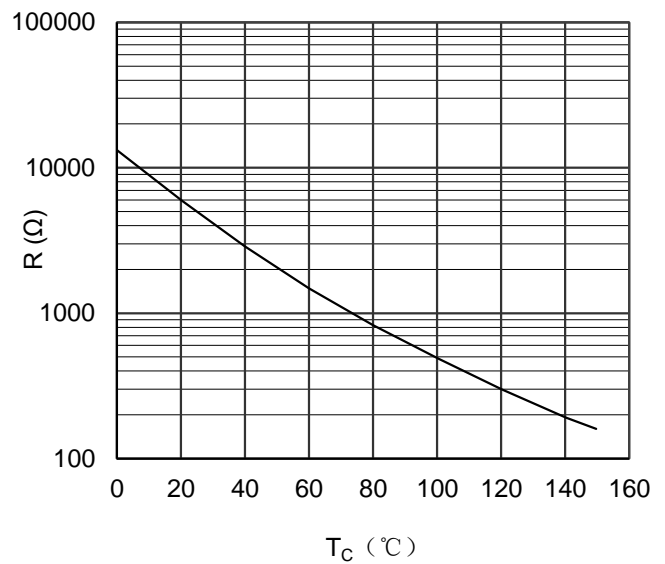


Figure 14. NTC Characteristics

MMG50HD120XB6TC

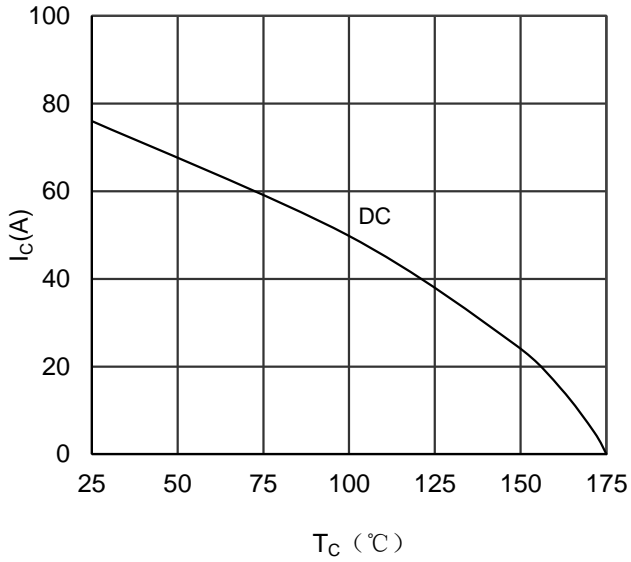


Figure 15. Collector Current vs Case temperature IGBT -inverter

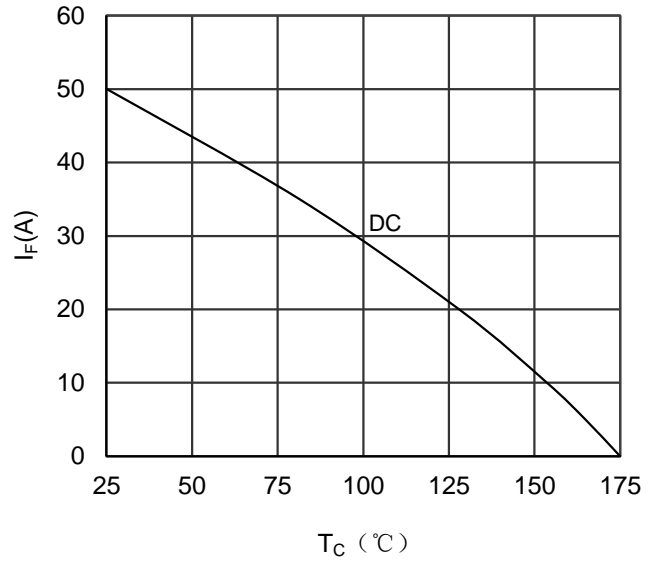


Figure 16. Forward current vs Case temperature Diode -inverter

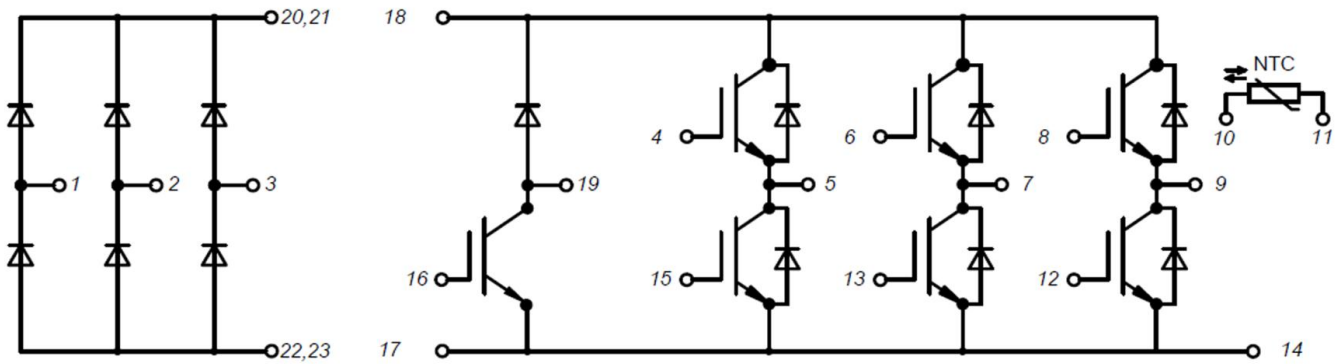
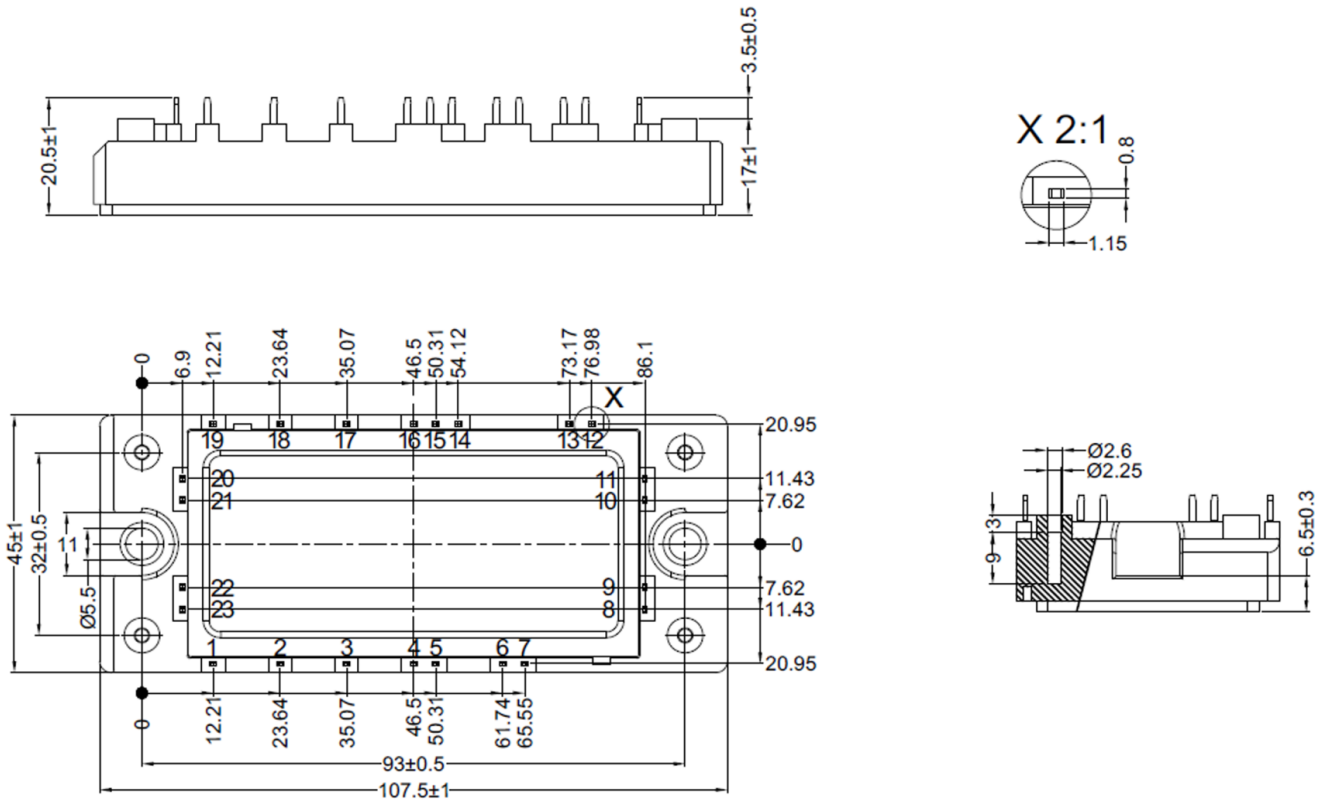


Figure 17. Circuit Diagram



Dimensions in (mm)
Figure 18. Package Outline